

**300mA, Ultra-low noise, Small Package**

**Ultra-Fast CMOS LDO Regulator**

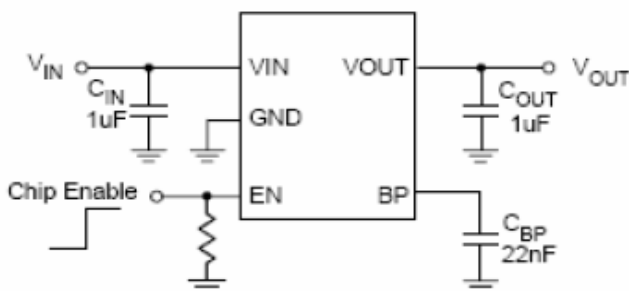
**General Description**

The LP3982 is designed for portable RF and wireless applications with demanding performance and space requirements. The LP3982 performance is optimized for battery-powered systems to deliver ultra low noise and low quiescent current. A noise bypass pin is available for further reduction of output noise. Regulator ground current increases only slightly in dropout, further prolonging the battery life. The LP3982 also works with low-ESR ceramic capacitors, reducing the amount of board space necessary for power applications, critical in hand-held wireless devices. The LP3982 consumes less than 0.01µA in shutdown mode and has fast turn-on time less than 50µs. The other features include ultra low dropout voltage, high output accuracy, current limiting protection, and high ripple rejection ratio. Available in the 5-lead of SC-70 packages.

**Ordering Information**

LP3982 -	□	□	□	□	□
	F: Pb-Free				
	Package Type				
	J5: SC-70				
	Output Voltage Type				
	15: 1.5V				
	18: 1.8V				
	25: 2.5V				
	28: 2.8V				
	30: 3.0V				
	33: 3.3V				

**Typical Application Circuit**



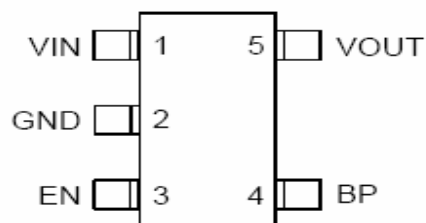
**Features**

- ◆ Ultra-Low-Noise for RF Application
- ◆ 2V- 6V Input Voltage Range
- ◆ Low Dropout : 220mV @ 300mA
- ◆ 1.2V, 1.5V, 1.8V, 2.5V, 2.8V 3.0V and 3.3V Fixed
- ◆ 300mA Output Current, 550A Peak Current
- ◆ High PSSR:-80dB at 1KHz
- ◆ < 0.01µA Standby Current When Shutdown
- ◆ Available in SC-70-5 Package
- ◆ TTL-Logic-Controlled Shutdown Input
- ◆ Ultra-Fast Response in Line/Load transient
- ◆ Current Limiting and Thermal Shutdown Protection
- ◆ Quick start-up (typically 50uS)

**Applications**

- ◇ Portable Media Players/MP3 players
- ◇ Cellular and Smart mobile phone
- ◇ LCD
- ◇ DSC Sensor
- ◇ Wireless Card

**Pin Configurations**



SC-70(Top View)

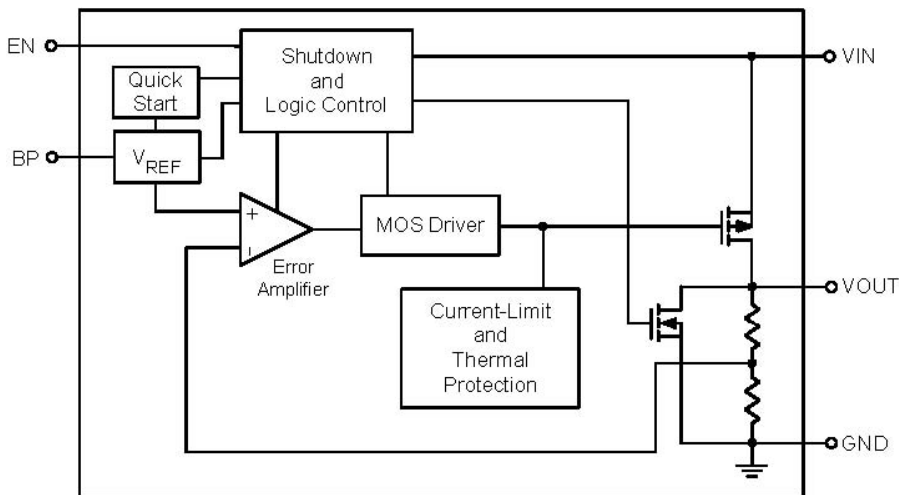
**Marking Information**

Please see website.

### Functional Pin Description

Pin Name	Pin Function
EN	Chip Enable (Active High). Note that this pin is high impedance. There should be a pull low 100kΩ resistor connected to GND when the control signal is floating.
BP	Reference Noise Bypass
GND	Ground
VOUT	Output Voltage
VIN	Power Input Voltage

### Function Block Diagram



### Absolute Maximum Ratings

- Supply Input Voltage-----6V
- Power Dissipation, PD @ TA = 25° C
- SC-70 -----400mW
- Package Thermal Resistance
- SC-70, θJA -----250°C/W
- Lead Temperature (Soldering, 10 sec.) -----260°C
- Storage Temperature Range ----- -65°C to 150°C

#### ESD Susceptibility

- HBM (Human Body Mode) -----2kV
- MM(Machine-Mode)-----200V

#### Recommended Operating Conditions

- Supply Input Voltage-----2.5V to 5.5V
- EN Input Voltage -----0V to 5.5V
- Operation Junction Temperature Range ----- -40°C to 125°C
- Operation Ambient TemperatureRange----- -40°C to 85°C

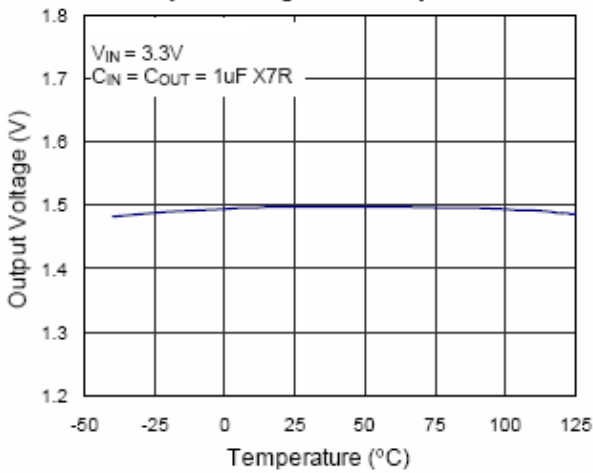
**Electrical Characteristics**

(VIN = VOUT + 1V, CIN = COUT = 1μF, CBP = 22nF, TA = 25° C, unless otherwise specified)

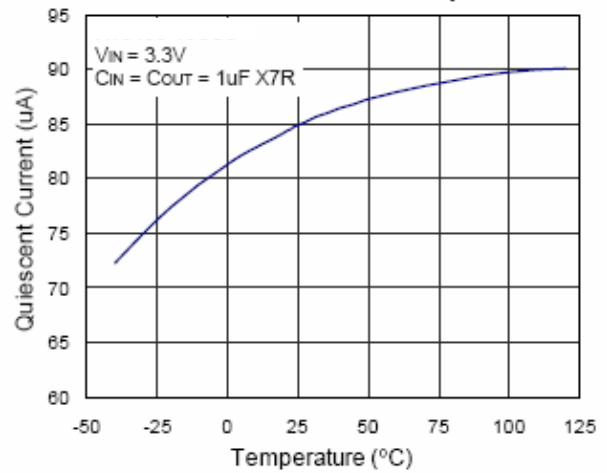
Parameter	Symbol	Test Conditions	Min	Typ	Max	Units	
Output Voltage Accuracy	ΔVOUT	IOUT = 1mA	-2	--	+2	%	
Current Limit	ILIM	RLOAD = 1Ω	360	400		mA	
Quiescent Current	IQ	VEN ≥ 1.2V, IOUT = 0mA		90	130	μA	
Dropout Voltage	VDROP	IOUT = 200mA, VOUT > 2.8V		170	200	mV	
		IOUT = 300mA, VOUT > 2.8V		220	300		
Line Regulation	ΔVLINE	VIN = (VOUT + 1V) to 5.5V, IOUT = 1mA			0.3	%	
Load Regulation	ΔLOAD	1mA < IOUT < 300mA			0.6	%	
Standby Current	ISTBY	VEN = GND, Shutdown		0.01	1	μA	
EN Input Bias Current	IIBSD	VEN = GND or VIN		0	100	nA	
EN Threshold	Logic-Low Voltage	VIL	VIN = 3V to 5.5V, Shutdown			0.4	V
	Logic-High Voltage	VIH	VIN = 3V to 5.5V, Start-Up	1.2			
Output Noise Voltage		10Hz to 100kHz, IOUT = 200mA COUT = 1μF		100		μVRMS	
Power Supply Rejection Rate	f = 100Hz f = 10kHz	PSRR		-80		dB	
		COUT = 1μF, IOUT = 10mA		-55			
Thermal Shutdown Temperature	TSD			165		°C	

## Typical Operating Characteristics

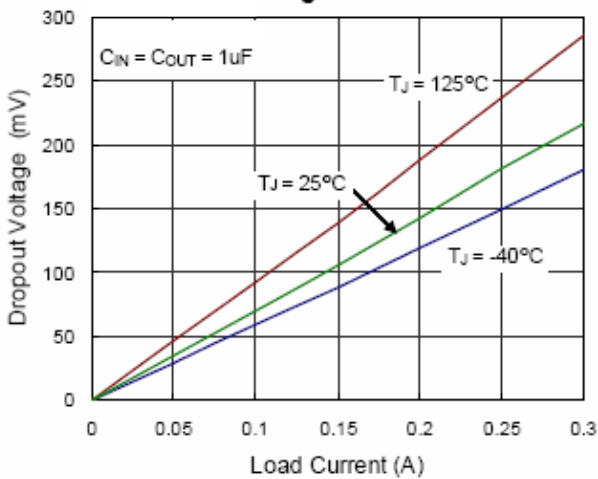
Output Voltage vs. Temperature



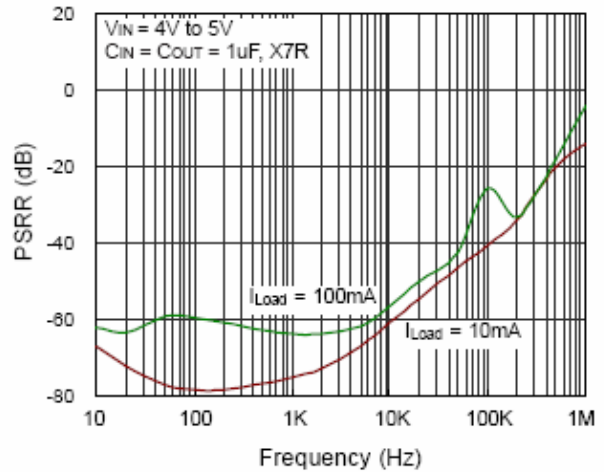
Quiescent Current vs. Temperature



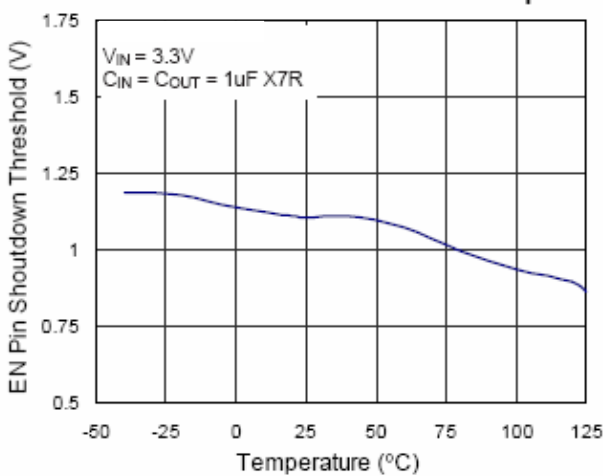
Droop Voltage vs. Load Current



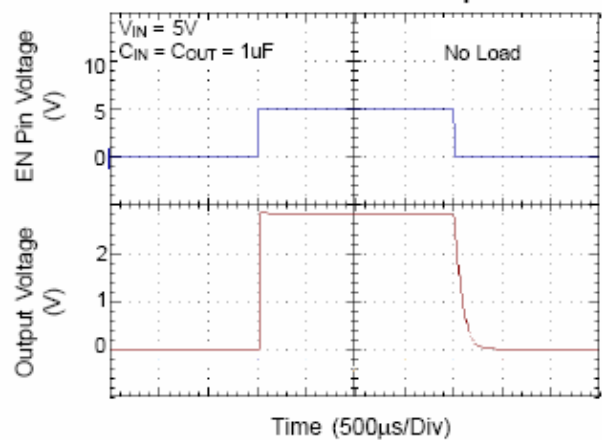
PSRR



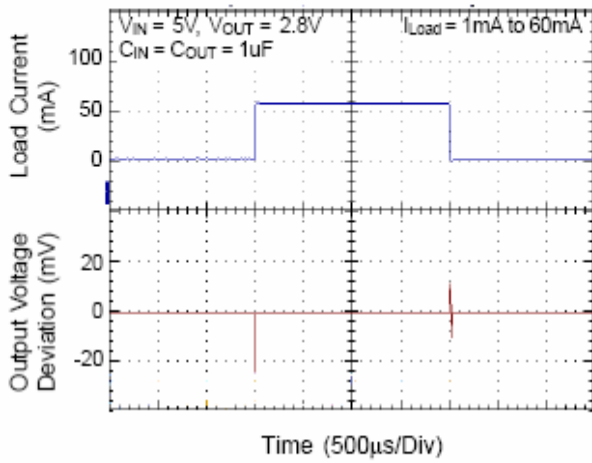
EN Pin Shutdown Threshold vs. Temperature



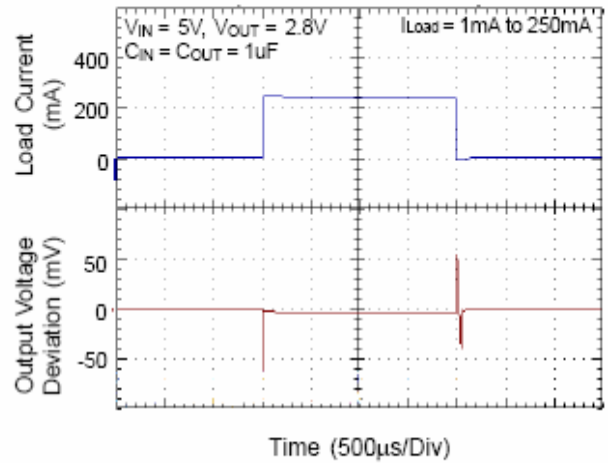
EN Pin Shutdown Response



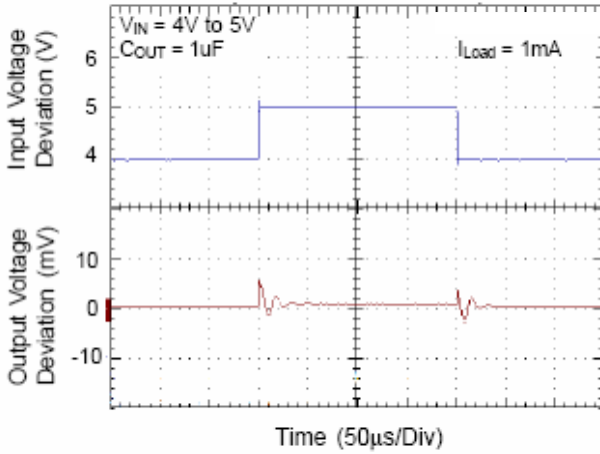
Load Transient Response



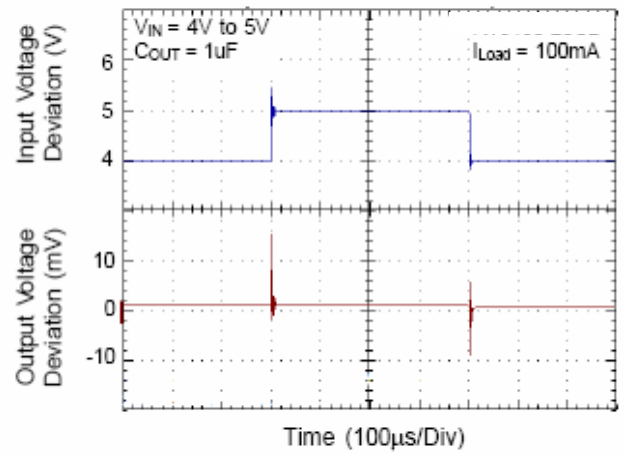
Load Transient Response



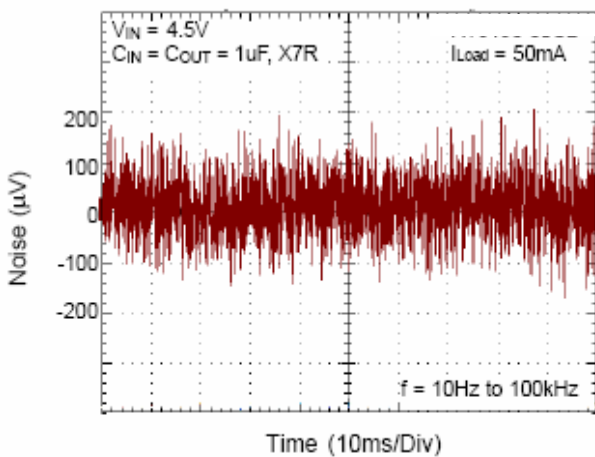
Line Transient Response



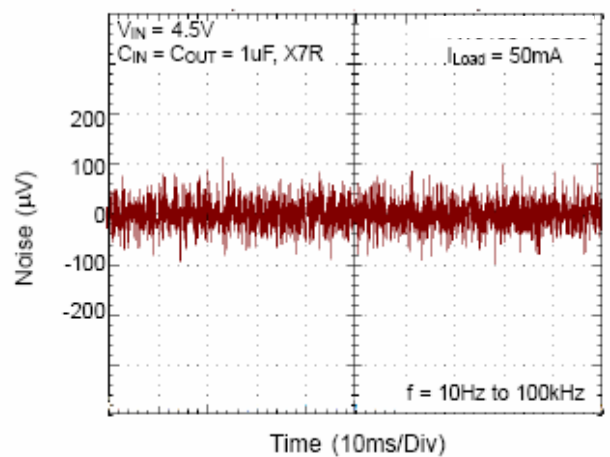
Line Transient Response



Noise



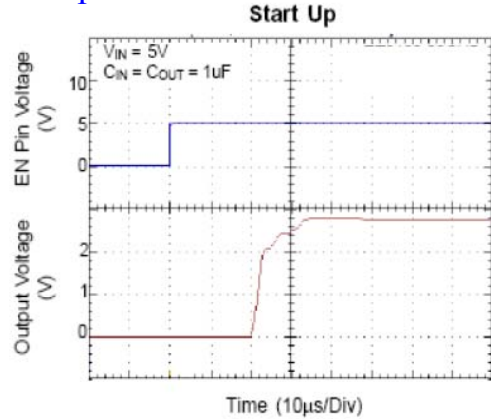
Noise



**Applications Information**

Like any low-dropout regulator, the external capacitors used with the LP3982 must be carefully selected for regulator stability and performance. Using a capacitor whose value is  $> 1\mu\text{F}$  on the LP3982 input and the amount of capacitance can be increased without limit. The input capacitor must be located a distance of not more than 0.5 inch from the input pin of the IC and returned to a clean analog ground. Any good quality ceramic or tantalum can be used for this capacitor. The capacitor with larger value and lower ESR (equivalent series resistance) provides better PSRR and line-transient response. The output capacitor must meet both requirements for minimum amount of capacitance and ESR in all LDOs application. The LP3982 is designed specifically to work with low ESR ceramic output capacitor in space-saving and performance consideration. Using a ceramic capacitor whose value is at least  $1\mu\text{F}$  with ESR is  $> 25\text{m}\Omega$  on the LP3982 output ensures stability. The LP3982 still works well with output capacitor of other types due to the wide stable ESR range. Figure 1 shows the curves of allowable ESR range as a function of load current for various output capacitor values. Output capacitor of larger capacitance can reduce noise and improve load transient response, stability, and PSRR. The output capacitor should be located not more than 0.5 inch from the VOUT pin of the LP3982 and returned to a clean analog ground.

**Start-up Function Enable Function**



The LP3982 features an LDO regulator enable/disable function. To assure the LDO regulator will switch on, the EN turn on control level must be greater than 1.2 volts. The LDO regulator will go into the shutdown mode when the voltage on the EN pin falls below 0.4 volts. For to protecting the system, the LP3982 have a quick-discharge function. If the enable function is not needed in a specific application, it may be tied to VIN to keep the LDO regulator in a continuously on state.

**Bypass Capacitor and Low Noise**

Connecting a 22nF between the BP pin and GND pin significantly reduces noise on the regulator output, it is critical that the capacitor connection between the BP pin and GND pin be direct and PCB traces should be as short as possible. There is a relationship between the bypass capacitor value and the LDO regulator turn on time. DC leakage on this pin can affect the LDO regulator output noise and voltage regulation performance.

**Thermal Considerations**

Thermal protection limits power dissipation in LP3982. When the operation junction temperature exceeds  $165^{\circ}\text{C}$ , the OTP circuit starts the thermal shutdown function turn the pass element off. The pass element turn on again after the junction temperature cools by  $30^{\circ}\text{C}$ . For continue operation, do not exceed absolute maximum operation junction temperature  $125^{\circ}\text{C}$ .

The power dissipation definition in device is :

$$PD = (VIN - VOUT) \times IO_{OUT} + VIN \times IQ$$

The maximum power dissipation depends on the thermal resistance of IC package, PCB layout, the rate of surroundings airflow and temperature difference between junction to ambient.

The maximum power dissipation can be calculated by following formula :

$$PD(MAX) = (TJ(MAX) - TA) / \theta_{JA}$$

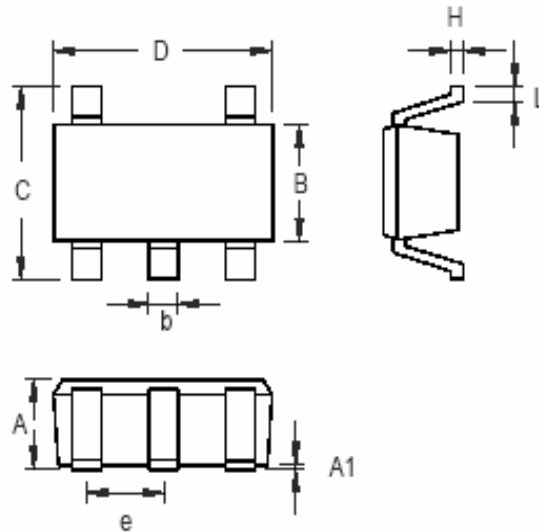
Where TJ(MAX) is the maximum operation junction temperature 125°C, TA is the ambient temperature and the  $\theta_{JA}$  is the junction to ambient thermal resistance. For recommended operating conditions specification of LP3982, where TJ(MAX) is the maximum junction temperature of the die (125°C) and TA is the maximum ambient temperature. The junction to ambient thermal resistance ( $\theta_{JA}$  is layout dependent) for SC-70-5 package is 250°C/W.

$$PD(MAX) = (125^{\circ}C - 25^{\circ}C) / 250 = 400mW \text{ (SC-70-5)}$$

$$PD(MAX) = (125^{\circ}C - 25^{\circ}C) / 165 = 606mW$$

The maximum power dissipation depends on operating ambient temperature for fixed TJ(MAX) and thermal resistance  $\theta_{JA}$ .

Packaging Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.800	1.100	0.031	0.044
A1	0.000	0.100	0.000	0.004
B	1.150	1.350	0.045	0.054
b	0.150	0.400	0.006	0.016
C	1.800	2.450	0.071	0.096
D	1.800	2.250	0.071	0.089
e	0.650		0.026	
H	0.080	0.260	0.003	0.010
L	0.210	0.460	0.008	0.018

SC-70-5 Surface Mount Package